

General purpose high voltage amplifier in bare die form

Complement to PNP SiS953

Features:

- 100 Volt V_{CEO}
- Very low V_{CE(sat)}
- High gain across wide current range
- High reliability gold back metal
- High reliability tested grades for Military + Space

Ordering Information:

The following part suffixes apply:

- No suffix MIL-STD-750 /2072 Visual Inspection
- "H" MIL-STD-750 /2072 Visual Inspection + MIL-STD-38534 Class H LAT
- "K" MIL-STD-750 /2072 Visual Inspection + MIL-STD-38534 Class K LAT

LAT = Lot Acceptance Test.

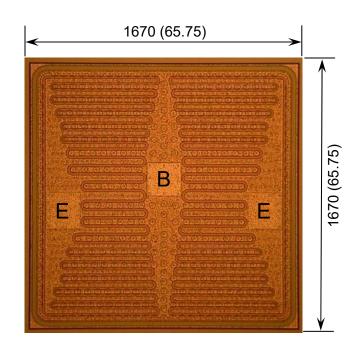
For further information on LAT process flows see below.

www.siliconsupplies.com\quality\bare-die-lot-qualification

Supply Formats:

- Default Die in Waffle Pack (100 per tray capacity)
- Sawn Wafer on Tape Specific request
- Unsawn Wafer Specific request
- With additional electrical selection Specific request
- Sawn as pairs or adjacent pair pick Specific request

Die Dimensions in µm (mils)



E = EMITTER **B** = BASE

DIE BACK = COLLECTOR

Mechanical Specification

Die Size (Excluding Saw Street)	1670 x 1670 65.75 x 65.75	µm mils	
Base Pad Size	200 x 200 7.87 x 7.87	µm mils	
Emitter Pad Size	200 x 220 7.87 x 8.66		
Die Thickness	230 (±20) 9.06 (±0.79)	µm mils	
Top Metal Composition	Al-Si		
Back Metal Composition	Au		



Rev 1.1

13/10/23



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Absolute Maximum Ratings T_A = 25°C unless otherwise stated

PARAMETER	SYMBOL	VALUE	UNIT
Collector-Base Voltage	V _{CBO}	200	V
Collector-Emitter Voltage	V _{CEO}	100	V
Emitter-Base Voltage	V _{EBO}	6	V
Collector Current	I _C	6	A
Collector Current Pulsed	Ісм	10	A
Junction Temperature	TJ	150	°C
Storage Temperature	T _{stg}	-55 to 150	°C

Electrical Characteristics $T_A = 25^{\circ}C$ unless otherwise stated

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	V _{(BR)CBO}	I _C = 100μA	200	220	-	V
Collector-Emitter Breakdown Voltage	V _{(BR)CEO}	I _C = 10mA	100	110	-	V
Emitter-Base Breakdown Voltage	V _{(BR)EBO}	I _E = 100μA	6	8	-	V
Collector Cut-off Current	I _{CBO}	V _{CB} = 150V	-	-	6	nA
Emitter Cut-off Current	I _{EBO}	V _{EB} = 6V	-	-	6	nA
ON CHARACTERISTICS						
Forward-Current Transfer Ratio	h _{FE}	$V_{CE} = 2V, I_{C} = 10mA$	140	-	-	-
		$V_{CE} = 2V, I_C = 2A$	140	200	300	-
		$V_{CE} = 2V, I_C = 4A$	60	100	-	
		V _{CE} = 2V, I _C = 10A	-	30	-	-
Collector-Emitter Saturation Voltage	V _{CE(sat)}	I _C = 100mA, I _B = 5mA	-	22	45	mV
		I _C = 2A, I _B = 100mA	-	135	160	mV
		I _C = 5A, I _B = 250mA	-	300	380	mV
Base Saturation Voltage	V _{BE(sat)}	I _C = 5A, I _B = 250mA	-	1.00	1.10	V
	V _{BE(on)}	$V_{CE} = 2V, I_C = 5A$	-	1.10	1.15	V
SMALL SIGNAL CHARACTERISTICS ¹						
Transition Frequency	f _T	V _{CE} = 10V, I _E = -100mA	-	190	-	MHz
Collector Output Capacitance	C _{obo}	V _{CB} = 10V, I _E = 0, f = 1MHz	-	38	-	pF

Note 1: Not production testing in die form. Characterized by chip design and package test.

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